Eighteenth Annual





PRELIMINARY CALL FOR PRESENTATIONS

This is the preliminary call for technical presentations for the 2009 Single Event Effects (SEE) Symposium. The meeting will be held on April 20-22, 2009 at the Marriott Hotel in La Jolla, CA. We invite papers addressing all aspects of SEE in microelectronic and photonic devices, circuits, and systems. Topics include (but are not limited to):

- <u>Phenomena:</u> Upset, Transient, Latchup, Gate Rupture, Burnout, Destructive Effects in Bipolar Devices, Microdosimetric Effects, Multiple Event Upset, Dark Current, Error Propagation.
- Basic Mechanisms and Modeling: Destructive and Non-Destructive Effects, Nanoscale Phenomena, Effect of Operating Speed, Charge Transport and Collection, Impact of Circuit and Environmental Parameters, including temperature and aging.
- <u>SEE Mitigation Methods Including Hardened by Design (HBD) and by Process:</u> Approaches for gaining SEE hardness in commercial devices.
- Environments and Facilities: Space, Atmospheric and Terrestrial environments. Heavy Ion, Proton, Neutron and Laser Test Facilities.
- Operational Regimes and Performance Data: Systems and Devices at LEO to Geosynchronous and Beyond, High Altitude Aircraft, and Terrestrial.
- <u>Electronic & Photonic Device Data:</u> Memories, Latches, Analog Circuits, Microprocessors, FPGAs, Optocouplers, DC to DC Converters, Sensors, Commercial and Hardened Components.
- Systems: Error Mitigation, Error Detection & Correction, Multi-core Processing, and Fault Tolerant Systems.

Special consideration will be given to complex device testing and effect analysis.

All interested personnel are invited to send a one-page abstract by **February 20, 2009** to <u>Steven.S.Mcclure@jpl.nasa.gov</u>. A voluntary submission to a Symposium Proceeding is also requested. Submissions may either be annotated charts or a short paper (≤ 6 pages) based on the presentation. When submitting an abstract, please notify us of your publishing intent. The SEE Symposium will be unclassified and welcomes international participation. Authors are responsible for obtaining clearances to present their work.

For information on having an industrial exhibit please contact Penny Meeker: pennym@us-semi.com .

The Symposium is supported by the Defense Threat Reduction Agency, the NASA Electronic Parts and Packaging Program, The Aerospace Corporation, the Naval Research Laboratory, and Vanderbilt University.

Registration opened on January 1, 2009

For more information please visit the SEE Symposium website:

http://radhome.gsfc.nasa.gov/radhome/SEE/index.html